N-channel 80 V 8.7 mΩ standard level MOSFET in TO-220Rev. 02 — 1 November 2010Product data

Product data sheet

#### **Product profile** 1.

#### **1.1 General description**

Standard level N-channel MOSFET in TO-220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

#### 1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for standard level gate drive

#### 1.3 Applications

- DC-to-DC converters
- Load switching

- Motor control
- Server power supplies

#### 1.4 Quick reference data

#### Table 1. **Quick reference data**

|                      | quient i or or or or or out                        |  |              |     |     |     |      |
|----------------------|--|--|--------------|-----|-----|-----|------|
| Symbol               | Parameter  | Conditions   | N            | lin | Тур | Мах | Unit |
| V <sub>DS</sub>      | drain-source voltage                               | T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C  | -            |     | -   | 80  | V    |
| I <sub>D</sub>       | drain current                                      | $T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$<br>see <u>Figure 1</u>  | -            |     | -   | 90  | A    |
| P <sub>tot</sub>     | total power dissipation                            | T <sub>mb</sub> = 25 °C; see Figure 2  | -            |     | -   | 170 | W    |
| Tj                   | junction temperature                               |  | -5           | 55  | -   | 175 | °C   |
| Static char          | racteristics                                       |  |              |     |     |     |      |
| R <sub>DSon</sub>    | drain-source on-state resistance                   | $\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \text{ V}; \text{ I}_{D} = 10 \text{ A}; \\ T_{j} = 100 \text{ °C}; \text{ see } \underline{\text{Figure } 12} \end{array}$                             | -            |     | -   | 14  | mΩ   |
|                      |  | V <sub>GS</sub> = 10 V; I <sub>D</sub> = 10 A;<br>T <sub>j</sub> = 25 °C; see <u>Figure 13</u>   | <u>[1]</u> - |     | 7.5 | 8.7 | mΩ   |
| Dynamic o            | haracteristics                                     |  |              |     |     |     |      |
| Q <sub>GD</sub>      | gate-drain charge                                  | $V_{GS}$ = 10 V; $I_{D}$ = 25 A;   | -            |     | 11  | -   | nC   |
| Q <sub>G(tot)</sub>  | total gate charge                                  | $V_{DS} = 40 \text{ V}; \text{ see } \frac{\text{Figure } 14}{\text{Figure } 15}$  | -            |     | 52  | -   | nC   |
| Avalanche            | ruggedness   |  |              |     |     |     |      |
| E <sub>DS(AL)S</sub> | non-repetitive<br>drain-source avalanche<br>energy | $ \begin{array}{l} V_{GS} = 10 \text{ V};  T_{j(\text{init})} = 25 ^\circ\text{C}; \\ I_D = 90 \text{ A};  V_{sup} \leq 80 \text{ V}; \\ \text{R}_{GS} = 50  \Omega; \text{ unclamped} \end{array} $ | -            |     | -   | 120 | mJ   |
|                      |  |  |              |     |     |     |      |

[1] Measured 3 mm from package.



#### N-channel 80 V 8.7 m $\Omega$ standard level MOSFET in TO-220

### 2. Pinning information

| Table 2. | Pinning | j information                     |                    |                |
|----------|---------|-----------------------------------|--------------------|----------------|
| Pin      | Symbol  | Description                       | Simplified outline | Graphic symbol |
| 1        | G       | gate                              |                    | _              |
| 2        | D       | drain                             | mb                 |                |
| 3        | S       | source                            |                    |                |
| mb       | D       | mounting base; connected to drain |                    | mbb076 S       |
|          |         |                                   | SOT78 (TO-220AB)   |                |

### 3. Ordering information

#### Table 3.Ordering information

| Type number  | Package  |  |         |
|--------------|----------|--|---------|
|              | Name     | Description  | Version |
| PSMN8R7-80PS | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78   |

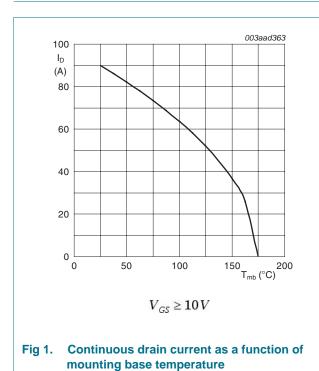
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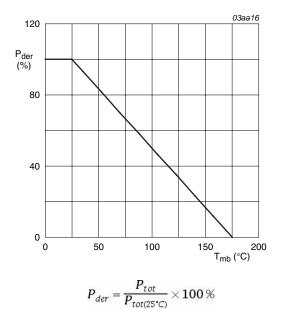
### 4. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Cumb al              | Devenueter                                      | Conditions  | N/1: | Max | 11   |
|----------------------|---|---|------|-----|------|
| Symbol               | Parameter                                       | Conditions  | Min  | Мах | Unit |
| V <sub>DS</sub>      | drain-source voltage                            | T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C   | -    | 80  | V    |
| V <sub>DGR</sub>     | drain-gate voltage                              | $T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$                                    | -    | 80  | V    |
| V <sub>GS</sub>      | gate-source voltage                             |   | -20  | 20  | V    |
| I <sub>D</sub>       | drain current                                   | V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; see <u>Figure 1</u>   | -    | 64  | А    |
|                      |   | $V_{GS}$ = 10 V; $T_{mb}$ = 25 °C; see <u>Figure 1</u>  | -    | 90  | А    |
| I <sub>DM</sub>      | peak drain current                              | pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$ ; see Figure 3   | -    | 361 | А    |
| P <sub>tot</sub>     | total power dissipation                         | T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>  | -    | 170 | W    |
| T <sub>stg</sub>     | storage temperature                             |   | -55  | 175 | °C   |
| Tj                   | junction temperature                            |   | -55  | 175 | °C   |
| T <sub>sld(M)</sub>  | peak soldering temperature                      |   | -    | 260 | °C   |
| Source-drain         | diode   |   |      |     |      |
| I <sub>S</sub>       | source current                                  | T <sub>mb</sub> = 25 °C   | -    | 90  | А    |
| I <sub>SM</sub>      | peak source current                             | pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$  | -    | 361 | А    |
| Avalanche ru         | ggedness  |   |      |     |      |
| E <sub>DS(AL)S</sub> | non-repetitive drain-source<br>avalanche energy | $V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_D$ = 90 A;<br>$V_{sup} \le 80$ V; $R_{GS}$ = 50 $\Omega$ ; unclamped | -    | 120 | mJ   |

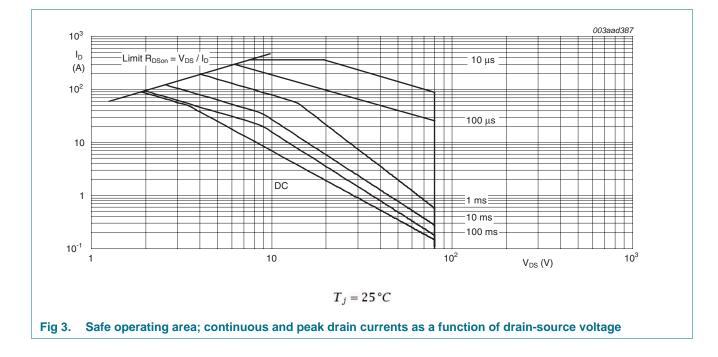






# PSMN8R7-80PS

#### N-channel 80 V 8.7 m $\Omega$ standard level MOSFET in TO-220

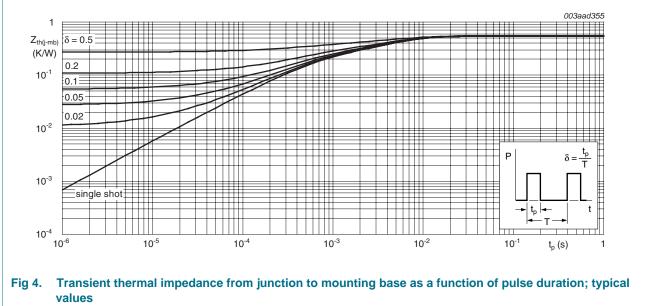


PSMN8R7-80PS Product data sheet N-channel 80 V 8.7 mΩ standard level MOSFET in TO-220

#### **Thermal characteristics** 5.

Thermal characteristics

| Symbol                | Parameter   | Conditions          | Min | Тур  | Max  | Unit |
|-----------------------|---|---------------------|-----|------|------|------|
| R <sub>th(j-mb)</sub> | thermal resistance from junction to mounting base | see <u>Figure 4</u> | -   | 0.54 | 0.88 | K/W  |



N-channel 80 V 8.7 m $\Omega$  standard level MOSFET in TO-220

### 6. Characteristics

#### Table 6. Characteristics

Tested to JEDEC standards where applicable.

| Symbol   | Parameter                         | Conditions  | Min          | Тур  | Max       | Unit |
|--|-----------------------------------|---|--------------|------|-----------|------|
| Static char  | acteristics                       |   |              |      |           |      |
| V <sub>(BR)DSS</sub>                               | drain-source breakdown voltage    | $I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ\text{C}$   | 73           | -    | -         | V    |
|  |                                   | $I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$  | 80           | -    | -         | V    |
| V <sub>GS(th)</sub> gate-source                    | gate-source threshold voltage     | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$<br>see <u>Figure 10</u>                                    | 1            | -    | -         | V    |
|  |                                   | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$<br>see Figure 10   | -            | -    | 4.6       | V    |
|  |                                   | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$<br>see <u>Figure 11</u> ; see <u>Figure 10</u>              | 2.3          | 3    | 4         | V    |
| I <sub>DSS</sub>                                   | drain leakage current             | $V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$  | -            | 0.3  | 5         | μA   |
|  |                                   | $V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$   | -            | -    | 100       | μA   |
| I <sub>GSS</sub>                                   | gate leakage current              | $V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C   | -            | 10   | 100       | nA   |
|  |                                   | $V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$  | -            | 10   | 100       | nA   |
| R <sub>DSon</sub> drain-source on-state resistance | drain-source on-state resistance  | V <sub>GS</sub> = 10 V; I <sub>D</sub> = 10 A; T <sub>j</sub> = 175 °C;<br>see <u>Figure 12</u>                         | -            | -    | 20.8<br>8 | mΩ   |
|  |                                   | V <sub>GS</sub> = 10 V; I <sub>D</sub> = 10 A; T <sub>j</sub> = 100 °C;<br>see <u>Figure 12</u>                         | -            | -    | 14        | mΩ   |
|  |                                   | V <sub>GS</sub> = 10 V; I <sub>D</sub> = 10 A; T <sub>j</sub> = 25 °C;<br>see <u>Figure 13</u>                          | <u>[1]</u> - | 7.5  | 8.7       | mΩ   |
| R <sub>G</sub>                                     | internal gate resistance (AC)     | f = 1 MHz   | -            | 1    | -         | Ω    |
| Dynamic o  | haracteristics                    |   |              |      |           |      |
| Q <sub>G(tot)</sub>                                | total gate charge                 | $I_D = 0 \text{ A}; \text{ V}_{DS} = 0 \text{ V}; \text{ V}_{GS} = 10 \text{ V}$  | -            | 44   | -         | nC   |
|  |                                   | $I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$   | -            | 52   | -         | nC   |
| Q <sub>GS</sub>                                    | gate-source charge                | see Figure 14; see Figure 15  | -            | 15   | -         | nC   |
| Q <sub>GS(th)</sub>                                | pre-threshold gate-source charge  | $I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$   | -            | 9.2  | -         | nC   |
| Q <sub>GS(th-pl)</sub>                             | post-threshold gate-source charge | see Figure 14   | -            | 5.8  | -         | nC   |
| $Q_{GD}$   | gate-drain charge                 | $I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$<br>see Figure 14; see Figure 15                     | -            | 11   | -         | nC   |
| V <sub>GS(pl)</sub>                                | gate-source plateau voltage       | $I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; \text{ see } \frac{\text{Figure } 15}{100000000000000000000000000000000000$ | -            | 4.6  | -         | V    |
| C <sub>iss</sub>                                   | input capacitance                 | $V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; \text{ f} = 1 \text{ MHz};$   | -            | 3346 | -         | pF   |
| C <sub>oss</sub>                                   | output capacitance                | $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{1000}$  | -            | 296  | -         | pF   |
| C <sub>rss</sub>                                   | reverse transfer capacitance      |   | -            | 158  | -         | pF   |
| t <sub>d(on)</sub>                                 | turn-on delay time                | $V_{DS}$ = 40 V; $R_{L}$ = 1.6 Ω; $V_{GS}$ = 10 V;  | -            | 21   | -         | ns   |
| t <sub>r</sub>                                     | rise time                         | $R_{G(ext)} = 4.7 \Omega$   | -            | 26   | -         | ns   |
| t <sub>d(off)</sub>                                | turn-off delay time               |   | -            | 46   | -         | ns   |
| t <sub>f</sub>                                     | fall time                         |   | -            | 20   | -         | ns   |
| Source-dra   | ain diode                         |   |              |      |           |      |
| $V_{SD}$   | source-drain voltage              | I <sub>S</sub> = 10 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C;<br>see <u>Figure 17</u>                           | -            | 0.79 | 1.2       | V    |

### PSMN8R7-80PS

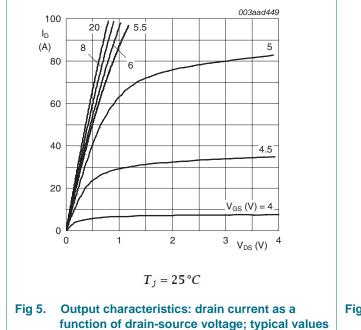
#### N-channel 80 V 8.7 m $\Omega$ standard level MOSFET in TO-220

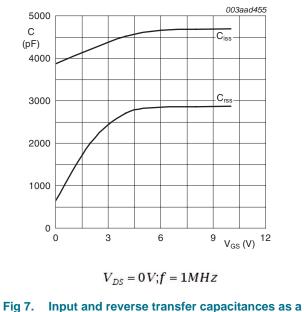
#### Table 6. Characteristics ...continued

Tested to JEDEC standards where applicable.

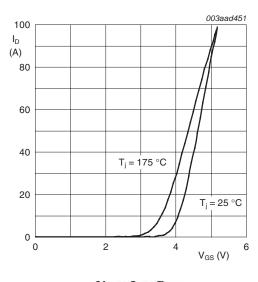
| Symbol          | Parameter             | Conditions   | Min | Тур | Max | Unit |
|-----------------|-----------------------|--|-----|-----|-----|------|
| t <sub>rr</sub> | reverse recovery time | $I_{S} = 25 \text{ A}; \text{ d}_{S}/\text{d}t = 100 \text{ A}/\mu\text{s};$ | -   | 42  | -   | ns   |
| Qr              | recovered charge      | $V_{GS} = 0 V; V_{DS} = 40 V$  | -   | 66  | -   | nC   |

[1] Measured 3 mm from package.



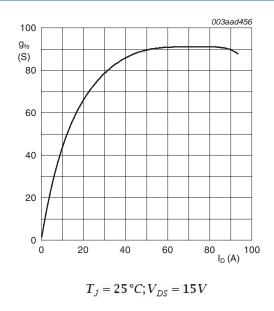






 $V_{DS} > I_D \times R_{DSon}$ 

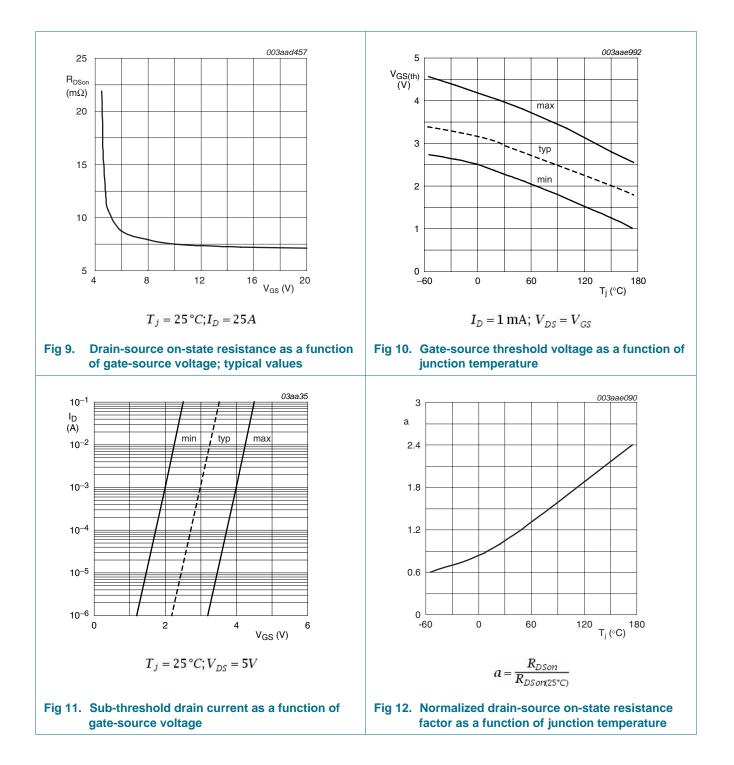






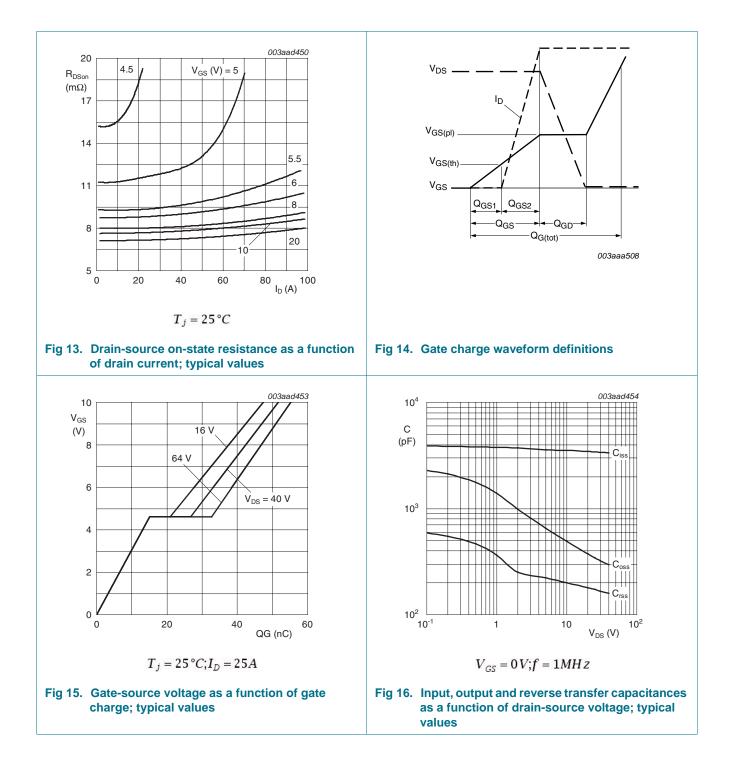
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#### N-channel 80 V 8.7 m $\Omega$ standard level MOSFET in TO-220



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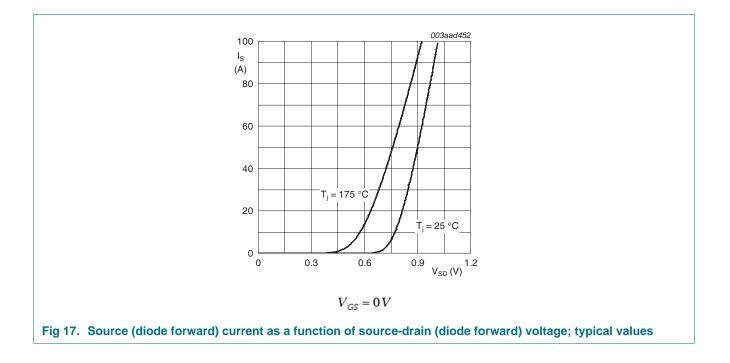
#### N-channel 80 V 8.7 m $\Omega$ standard level MOSFET in TO-220



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# PSMN8R7-80PS

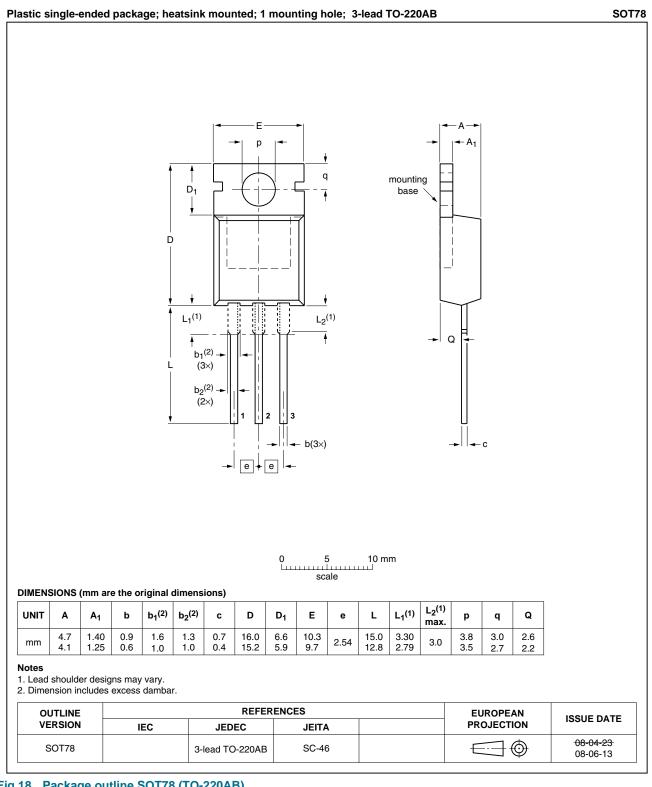
#### N-channel 80 V 8.7 m $\Omega$ standard level MOSFET in TO-220



### **PSMN8R7-80PS**

#### N-channel 80 V 8.7 mΩ standard level MOSFET in TO-220

#### **Package outline** 7.



#### Fig 18. Package outline SOT78 (TO-220AB)

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N-channel 80 V 8.7 mΩ standard level MOSFET in TO-220

### 8. Revision history

| Table 7. Revision h | nistory                           |                              |               |                  |
|---------------------|-----------------------------------|------------------------------|---------------|------------------|
| Document ID         | Release date                      | Data sheet status            | Change notice | Supersedes       |
| PSMN8R7-80PS v.2    | 20101101                          | Product data sheet           | -             | PSMN8R7-80PS v.1 |
| Modifications:      | <ul> <li>Status change</li> </ul> | d from objective to product. |               |                  |
|                     | <ul> <li>Various chang</li> </ul> | es to content.               |               |                  |
| PSMN8R7-80PS v.1    | 20100129                          | Objective data sheet         | -             | -                |

PSMN8R7-80PS Product data sheet

### 9. Legal information

#### 9.1 Data sheet status

| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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